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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Scott M. Zimmerman, et al.

Docket: OM-1670

Serial Number: 09/808,752

Group Art Unit: 4335

Filed: March 15, 2001

Examiner: Anita K. Alanko

For: POLYIMIDE ADHESION ENHANCEMENT TO POLYIMIDE FILM

OFFICIAL

NOTICE: THIS APPLICATION IS UNDER FINAL REJECTION

AMENDMENT

Commissioner for Patents  
P.O. BOX 1450  
Alexandria, Virginia 22313-1450

Sir:

In response to the Office Action mailed July 31, 2003, please amend the above identified patent application as follows:

In the claims:

1. (Withdrawn and Previously Amended) A process for forming a printed circuit board composite comprising:

- a) etching at least one surface of a polyimide substrate;
- b) coating a first polyimide film onto a surface of a metal foil; and
- c) laminating the first polyimide film onto the substrate by:
  - i.) laminating the first polyimide film directly onto at least one etched surface of the substrate, or

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**FAX COVER SHEET**

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DATE: September 25, 2003

KINDLY DIRECT THIS COMMUNICATION TO:

EXAMINER : Anita K. Alanko  
GROUP :1765

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